



P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
- 30	0.046 at $V_{GS} = -4.5 \text{ V}$	- 6.3	17		
- 30	0.065 at V _{GS} = - 2.5 V	- 5.3	17		

FEATURES

- TrenchFET® Power MOSFET
- MICRO FOOT[®] Chipscale Packaging Reduces Footprint Area Profile (0.62 mm) and On-Resistance Per Footprint Area



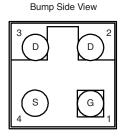
ROHS COMPLIANT

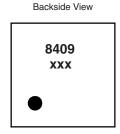
• Pin Compatible to Si8401DB

APPLICATIONS

 Load Switch, Battery Switch, and PA Switch for Portable Devices

MICRO FOOT

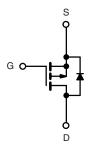




Device Marking: 8409

xxx = Date/Lot Traceability Code

Ordering Information: Si8409DB-T1-E1 (Lead (Pb)-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	- 30		٧	
Gate-Source Voltage		V _{GS}	± 12			
Continuous Drain Current /T 150 °C\8	T _A = 25 °C	I _D	- 6.3	- 4.6		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		- 5.1	- 3.7	^	
Pulsed Drain Current		I _{DM}	- 25		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	- 2.5	- 1.3		
Mariana Barra Biratiantian	T _A = 25 °C	P _D 2.77	2.77	1.47	W	
Maximum Power Dissipation ^a	T _A = 70 °C		1.77	0.94	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Package Reflow Conditions ^b	IR/Convection		260			

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mariana kandin ta Andriada	t ≤ 5 s	R _{thJA}	35	45	
Maximum Junction-to-Ambient ^a	Steady State	' ¹thJA	72	85	°C/W
Maximum Junction-to-Foot (drain)	Steady State	R _{thJF}	16	20	

Notes

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Refer to IPC/JEDEC (J-STD-020C), no manual or hand soldering.

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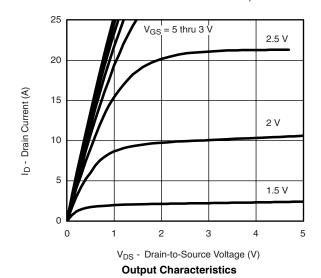
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.6		- 1.4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 \text{ °C}$			- 1	μΑ	
					- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$ - 5				Α	
_	D	V _{GS} = - 4.5 V, I _D = - 1 A		0.038	0.046	-	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 1 A		0.052	0.065	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 1 A		6.4		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 1 A, V _{GS} = 0 V		- 0.8	- 1.1	V	
Dynamic ^b	•						
Total Gate Charge	Q_g			17	26		
Gate-Source Charge	Q _{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1 \text{ A}$		2.2		nC	
Gate-Drain Charge	Q _{gd}			5.7			
Gate Resistance	R_{g}	f = 1 MHz		22		Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		35	55		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_{\text{D}}\cong$ - 1 A, V_{GEN} = - 4.5 V, R_{g} = 6 Ω		140	210	ns	
Fall Time	t _f			90	135		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1 A, dI/dt = 100 A/μs		85	130		

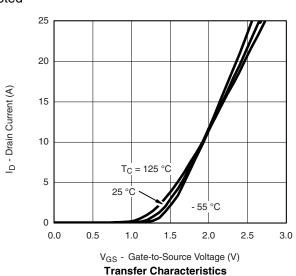
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



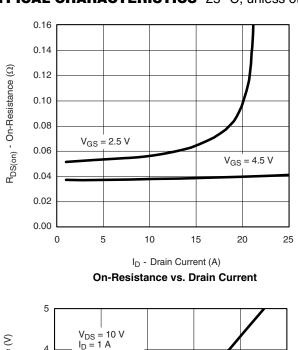


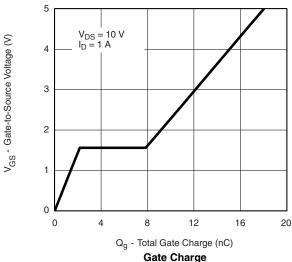


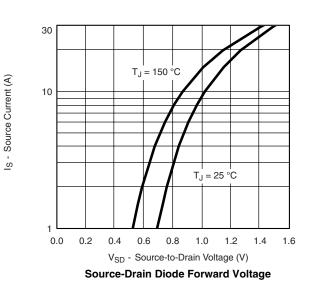


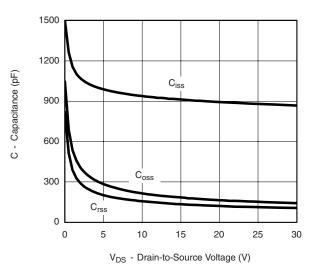


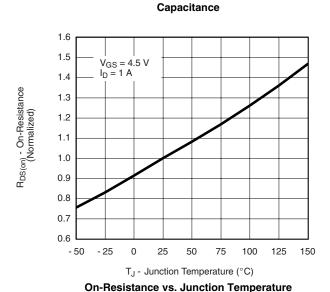
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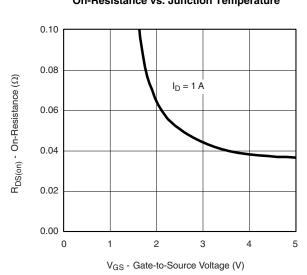










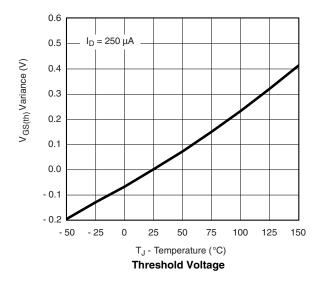


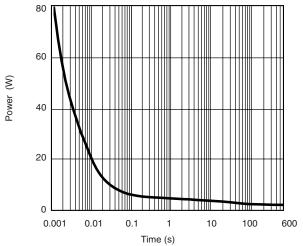
On-Resistance vs. Gate-to-Source Voltage

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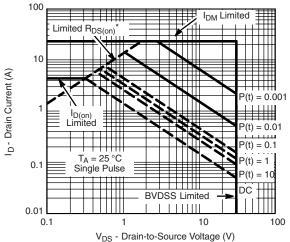
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



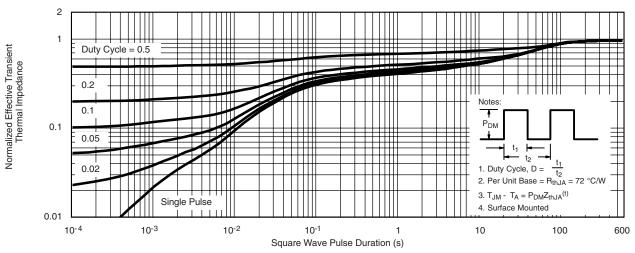


Single Pulse Power, Junction-to-Ambient



 v_{DS} - Drain-to-Source voltage (V) * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

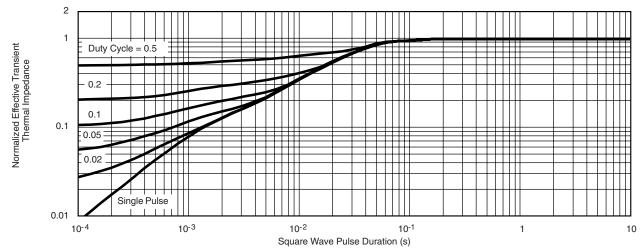
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



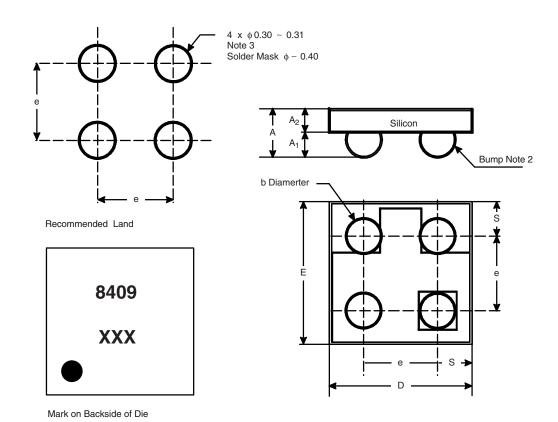
Normalized Thermal Transient Impedance, Junction-to-Foot

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PACKAGE OUTLINE

MICRO FOOT: 4-BUMP (2 x 2, 0.8 mm PITCH)



Notes (Unless Otherwise Specified):

- 1. Laser mark on the silicon die back, coated with a thin metal.
- 2. Bumps are 95.5/3.8/0.7 Sn/Ag/Cu.
- 3. Non-solder mask defined copper landing pad.
- 4. The flat side of wafers is oriented at the bottom.

Dim.	Millime	eters ^a	Incl	hes
	Min.	Max.	Min.	Max.
Α	0.600	0.650	0.0236	0.0256
A ₁	0.260	0.290	0.0102	0.0114
A ₂	0.340	0.360	0.0134	0.0142
b	0.370	0.410	0.0146	0.0161
D	1.520	1.600	0.0598	0.0630
E	1.520	1.600	0.0598	0.0630
е	0.750	0.850	0.0295	0.0335
S	0.370	0.380	0.0146	0.0150

Notes

 $\ensuremath{\mathrm{a}}.$ Use millimeters as the primary measurement.

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